TargetSystem

Dual Laser



Struers

Automatic target preparation to both visible and hidden targets - without losing samples

Modular, upgradable system

TargetMaster micropolisher with TargetDoser dosing system

- Use for any visible or hidden target e.g. microcracks, inclusions and porosities, oxidation layers, coatings
- Automatic preparation, cleaning and measuring
- Cross-sectioning and parallel polishing of both mounted and unmounted samples
- Real-time alignment of visible (external) and hidden (internal) targets
- On-board dual laser measuring system* provides $\pm~5~\mu m$ system accuracy
- IPS, Intelligent Preparation System
 IPS database with removal rates for grinding and polishing surfaces
 Automatic re-calculation of removal rate and time
- Low operating costs
 Use with any SiC paper, or any other consumable.

Your benefits:

- No samples lost
- Drastically reduced preparation time (< 30 minutes)
- No dependency on operator skills
- Full reproducibility
- No need for costly abrasive films



TargetX option for hidden targets



TargetZ option for visible targets

System components

With a system accuracy of \pm 5 µm, TargetSystem is for target and other high accuracy preparation in R&D or failure analysis (FA) labs. Typical application areas are microelectronics, delayering and FA where specific areas are to be inspected. The individual components of the system can be combined in several ways, according to requirements.



to target. A second, in-line laser measuring system handles the demanding polishing steps. TargetMaster can be used either stand-alone or with one of the two set-up stations, TargetZ or TargetX.

TargetGrip is a tiltable specimen holder dedicated to TargetMaster. Adapters are available for larger specimens (05756912), for cross-sectioning (05756908 and 05756914) and for parallel polishing (05756910).

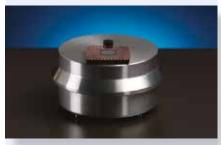


TargetGrip with 40 mm (05756908) and 30 mm (05756914) sample chair



TargetDoser is an automatic dosing station, providing preparation methods and process liquids to TargetMaster. TargetDoser comes with 7 pumps and 13 pre-programmed methods, and accommodates 200 user-defined methods.







Sample chair - Adapter for cross-sectioning, available in 30 mm (05756914) and 40 mm dia. (05756908)



Resin barrier (05756907) for use with Sample chair



Mould insert 40 mm (05756912), fully mounted and partially mounted

Preparation modes



TargetZ is used for aligning and measuring specimens with visible (external) targets.

With a powerful vision system of up to 680x magnification and its 15" TFT monitor, TargetZ makes it a simple task to map and align even minute targets.



TargetX is for hidden (internal) targets, and comprises a set-up station and a console. The set-up station is placed in the users x-ray (not included) and is operated from the external console, permitting real-time alignment and measuring.

TargetMaster offers three preparation modes, which can be used separately or in combination.







Removal

Target

Time

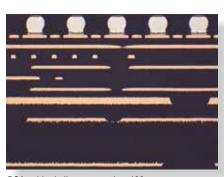
If e.g. consecutive layers of a specimen are inspected on a regular basis, **Removal mode** will take you to each of the layers with an accuracy of \pm 5 microns – and automatically stop when it is there.

TargetSystem does away with manual target polishing, which is particularly wasteful when microscopic targets of e.g. microelectronic components are subjects of a preparation. Here TargetMaster and its **Target mode** is used in combination with a set-up station, TargetX or TargetZ. The type of set-up station is selected depending on whether hidden (internal) or visible (external) targets on a specimen are to be inspected.

Using TargetX with an x-ray device, the hidden (internal) target of your sample can be aligned in real-time and the target value (distance to target) measured.

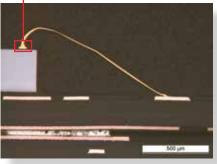
If, instead, visible (external) targets are the typical subject of inspection, TargetZ is the choice. With its powerful vision system even minute targets are precisely aligned and measured.

Time mode is for timed preparation, used e.g. for oxide polishing, and for manually controlled removal.



BGA solder ball, cross section, 100x





Overview and detail with 20 µm dia. Au-wirebond

Two measuring systems

IPS, Intelligent Preparation System



TargetMaster removal is controlled by two separate measuring systems. Grinding steps and removal until 175 µm from target (re diagram) are controlled by an electronic measuring system, which continuously measures distance to target. In this fashion, the major part of the target distance is covered as quickly as possible.

Polishing steps and removal below 175 μ m (re diagram) are handled by a laser measuring system. The system uses a unique, relative measuring technique enabling a remarkable \pm 5 μ m system accuracy.

TargetMaster features a system, IPS, which automatically adapts removal time and rate according to actual properties of specimen and grinding/polishing surface. In effect, fewer measurements are necessary, meaning shorter preparation times.

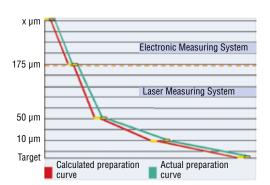
Before preparation starts, the sample height is measured and IPS calculates removal time for each of the steps (below diagram, in red). The removal times are based on the selected preparation method and base values (*Initial Removal Rates, IRR*). The base values are theoretical, conservative removal values for grinding and polishing surfaces, which are stored in the IPS database of TargetMaster.

Using the base values, preparation starts. After gaining experience with the properties of sample and surface, preparation stops and the actual amount of removed material is determined. On this basis, the actual removal rate for the first part of the step is calculated. The new, actual removal rate is then used for the remaining part of the step and so on (re diagram, in green). For less demanding jobs, it may be desirable to lower the accuracy

to make the preparation times as short as possible. Time/Accuracy factor is a tool for fine tuning the algorithm on which TargetMaster measuring is based. The default Time/Accuracy factor corresponds to setting '3', which can be lowered to '2', or '1'. Preparation times may get longer when increasing the Time/Accuracy factor, but overall depend on the preset IRR values.

For the easiest possible use of TargetSystem, we recommend the use of an inverted microscope, permitting inspection of the specimen while clamped into the sample holder (TargetGrip)

When using an upright microscope, it may become necessary to remove the specimen from the sample holder since the total height of holder + specimen exceeds the capacity of the microscope. Thus, if the specimen is to receive additional polishing, the original registration is likely to be lost.



IPS, How it Works

- · Accuracy is secured by using relative laser measuring
- Removal rate at first part of any step originates from built-in database (base values)
- Process is interrupted, laser measurement made, and removal rate + time re-calculated
- Remaining step at new removal rate





On-board dual laser measuring system provides ± 5 µm system accuracy

Using the TargetSystem Automatic target preparation in few, simple steps



Attach Sample

In seconds, the sample is glued directly into a single-use crosssectioning jig, sample chair. Mounting is not a requirement, but may be done





Mount TargetGrip in TargetMaster

Lock TargetGrip into sample mover of TargetMaster



Lock into holder

The sample chair is locked into TargetGrip, a precision sample holder



Select method

Select a suitable method on the automatic dosing system, and transmit to TargetMaster



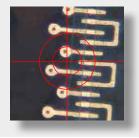
Place in set-up station

TargetGrip is locked into either TargetZ (for visible targets) or TargetX (for hidden targets)



Grind/polish

Automatic preparation to pre-selected target





Align

Real-time alignment of target



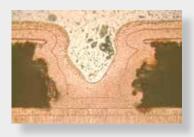
Inspect

Inspect the sample holder under microscope



Measure

Measurement of distance to target. Measured data is transferred to TargetMaster



TECHNICAL DATA

TargetSystem

System accuracy ± 5 µm at 20°C / 68°F ± 2°C / 4°F.

TargetMaster micropolisher

Diameter 200 mm / 8"

Speed, turntable 40 - 300 rpm in steps of 10 rpm Speed, specimen holder 20 - 150 rpm in steps of 10 rpm 10 - 75 N in steps of 5 N

Rotational direction CW / CCW Motor power 250 W / 0.33 HP

Software and electronics

Controls Touch pads

Memory FLASH-ROM / RAM / NV-RAM LC display 240 x 128 dots with back light

Noise levels

During preparation 54 dB (A) During cleaning 72 dB (A)

Working environment

5-40°C / 41-104°F. Temperature Humidity 35-50% RH

Supply

Voltage / frequency 200-240 V / 50-60 Hz

Power inlet 1-phase (N+L1+PE) or 2-phase (L1+L2+PE)

The electrical installation must comply with

"Installation Category II".

Power, nominal load 700 W Power, idle 16 W Current, nom. 3.5 A Current, max. 6.9 A

Pressure for tap water 1-10 bar / 14.5-145 psi

Water inlet 1/2" or 3/4" 32 mm / 1 1/4" dia. Water outlet 6 mm / 1/4" dia. Compressed air supply Compressed air pressure 6-10 bar / 87-145 psi

Compressed air quality In compliance with ISO 8573-1, 5.6.4 Air extraction 32 mm / 1 1/4" dia.

Air extraction, min. airflow 30 m³ / 1059 ft³ per hour

Dimensions and weight

820 mm / 32.3" 860 mm / 33.9" Depth Height 595 mm / 23.4" 115 kg / 253.5 lbs Weight

TargetGrip tiltable specimen holder

40 mm dia. (05756901) or 30 mm dia. (05756916) Specimen sizes

Cross-sectioning 40 mm dia. Sample chair, adapter for crosssectioning (05756908), max sample size

29 x 20.5 mm

30 mm dia. Sample chair, adapter for crosssectioning (05756914), max sample size

23 x 20.5 mm

Parallel polishing Parallel Holder 40 mm dia, adapter for parallel

polishing (05756910), max sample size 19 x 18

Parallel Holder 30 mm dia, adapter for parallel polishing (05756920), max sample size 15 x 9

± 5 degrees Tilt range Specimen holder dia. 58 mm 0.58 kg / 1.27 lb Weight

TargetDoser automatic dosing station

4 pumps for suspension/lubricant, Capacity

1 pump for OP-suspension,

1 pump for soap, 1 pump for alcohol

Dosing Levels

Suspensions 0.2-4.0 ml in 20 steps All-in-one suspensions 0.2-12.0 ml in 20 steps Lubricants 0.2-12.0 ml in 20 steps **OP-Suspensions** 20.0-90.0 ml in 20 steps

Software and electronics

Controls Touch pads

FLASH-ROM / RAM / NV-RAM Memory LC display 240x128 dots with back light

Workina environment

5-40°C / 41-104°F. Temperature Humidity 35-50% RH

Supply

Voltage 24 V DC, 1 A supplied from TargetMaster

Dimensions and weight

Width 200 mm / 8"

Depth excl. bottle tray 210 mm / 8.3" Depth incl. bottle tray 550 mm / 21.7" 380 mm / 15" Heiaht Weight excl. bottle tray 8.5 kg / 18.7 lbs Weight incl. bottle tray

10.0 kg / 22.0 lbs

TargetX set-up station for hidden (internal) targets

Software and electronics

Controls Touch pads

FLASH-ROM / RAM / NV-RAM Memory

Working environment

Temperature 5-40°C / 41-104°F. Humidity 35-50% RH

Supply

Voltage / frequency 200-240V / 50-60 Hz

Power inlet 1-phase (N+L1+PE) or 2-phase (L1+L2+PE)

The electrical installation must comply with

"Installation Category II".

Power, nominal load 50 W Power, idle 10 W 0.25 A Current, nom. Current, max. 1.0 A

Dimensions and weight

Width 705 mm / 27.7" Depth 385 mm / 15.1" Height 285 mm / 11.2" Weight 13 kg / 28.6 lbs

TECHNICAL DATA TargetZ set-up station for visible (external) targets

Software and electronics

Controls Touch pads Video display 15" TFT monitor

Working environment

5-40°C / 41-104°F. Temperature Humidity 35-50% RH

Supply

24 V DC, 1 A supplied from TargetMaster 200-240V / 50-60 Hz $\,$ Voltage

Video monitor

Dimensions and weight

235 mm / 9.3" Width 315 mm / 12.4" 205 mm / 8.1" Depth . Height Weight 15 kg / 33 lbs

Struers' equipment is in conformity with the provisions of the applicable International Directives and their appurtenant Standards. (Please contact you local supplier for details)



Coated sheet metal, zinc layer gas bubbles. Diameter ca 20 μm

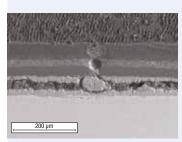


Photo courtesy: Volkswagen AG, Germany



Chromium PVD layer on steel, possible corrosion site, 50 x

Same as above, 500 x



Photo courtesy: Corus Group, Netherlands

SPECIFICATIONS	Cat.no.
TargetMaster 200 mm micropolisher for automatic target preparation. Tiltable holder for 30 mm specimens (05756916) and 200 mm MD-Disc (02426920) included. Dosing system (05756904) is ordered separately.	05756128
TargetGrip Tiltable specimen holder for 40 mm dia. specimens. Tiltable specimen holder for 30 mm dia. specimens.	05756901 05756916
TargetDoser Automatic dosing system for supply and storage of process liquids and preparation methods. With 6 pumps for suspension/lubricant, 1 pump for OP-suspension.	05756904
TargetX Set-up station for internal (hidden) targets. For use with x-ray not included with TargetX.	05756923
TargetZ Set-up station for external (visible) targets. With 15" TFT video monitor.	05756922
Sample chair 40 mm Adapter for cross-sectioning (disposable). Max specimen size 29 x 20.5 mm. 50 pcs. 30 mm Adapter for cross-sectioning (disposable). Max specimen size 23 x 20.5 mm. 50 pcs.	05756908 05756914
Sample Chair holder for CitoVac For easy handling of Sample Chairs. For 6 x 30 mm and 5 x 40 mm Sample Chairs.	05926905
Parallel holder 40 mm dia. Adapter for parallel polishing (re-usable). Max specimen size 19 x 18 mm. 30 mm dia. Adapter for parallel polishing (re-usable). Max specimen size 15 x 9 mm.	05756910 05756920
SEM Adapter Adapter 940 mm to 925 mm. Allows 25 mm/1" dia. specimens to be mounted in 940 mm TargetGrip. Also used as removable SEM-fixture.	05756905
Resin barrier Metal label for use with Sample chair (05756908 and 05756914). 50 pcs.	05756907
Mould Insert 40 mm dia. Mould insert for use with 40 mm dia. mounting cups. Max specimen size 35 x 20 mm. 50 pcs.	05756912
Measuring pin For use with Parallel Holder. 10 pcs. with O-ring. Re-usable	05756915



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